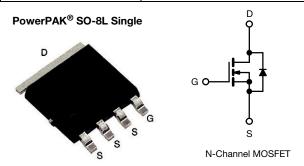
Vishay Siliconix

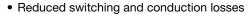
E Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	T _J max. 650				
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V	0.45			
Q _g max. (nC)	44				
Q _{gs} (nC)	5				
Q _{gd} (nC)	10				
Configuration	Single				



FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Switch mode power supplies (SMPS)
- Flyback converter
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Wall adaptors

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and Halogen-free	SiHJ8N60E-T1-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	V
0 11	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		8	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	Α
Pulsed Drain Current ^a			I _{DM}	18	
Linear Derating Factor				0.71	W/°C
Single Pulse Avalanche Energy b			E _{AS}	88	mJ
Maximum Power Dissipation			P _D	89	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C			-11 / / -14	70	1//
Reverse Diode dV/dt d			dV/dt	17	V/ns

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.5 A
- c. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum Junction-to-Ambient	R _{thJA}	52	65	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	1	1.4	C/VV		



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	2	-	4	V
Cata Saurea Laglana	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zero Gate Voltage Drain Current	1	V _{DS} =	600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 4 A$	-	0.45	0.52	Ω
Forward Transconductance	9fs	V _{DS}	= 30 V, I _D = 4 A	-	2.4	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	754	-	
Output Capacitance	C _{oss}	Ī ,	$V_{\rm DS} = 100 \rm V$	-	46	-	
Reverse Transfer Capacitance	C_{rss}		f = 1 MHz	-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	٧, ٥٠	/+- 400 V V 0 V	-	40	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	V _{DS} = 0 \	I to 480 V, $V_{GS} = 0 \text{ V}$	-	130	-	
Total Gate Charge	Q_g			-	22	44	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 4 A, V_{DS} = 480 V$	-	5	-	nC
Gate-Drain Charge	Q _{gd}			-	10	-	
Turn-On Delay Time	t _{d(on)}			-	14	28	
Rise Time	t _r	$V_{DD} = 480 \text{ V}, I_D = 4 \text{ A},$		-	15	30	
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	29	58	ns
Fall Time	t _f			-	14	28	
Gate Input Resistance	R _g	f = 1 MHz		0.5	0.93	2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	8	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	18	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 4 A, V _{GS} = 0 V	-	0.85	1.2	V
Reverse Recovery Time	t _{rr}			-	258	516	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	25 °C, I _F = I _{S = 4 A} , 100 Α/μs ^{, V} _R = 25 V	-	2.4	4.8	μC
Reverse Recovery Current	I _{RRM}	ai/at =	100 A/μS ^{, *} R = 25 V	_	16	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

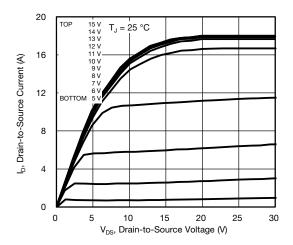


Fig. 1 - Typical Output Characteristics

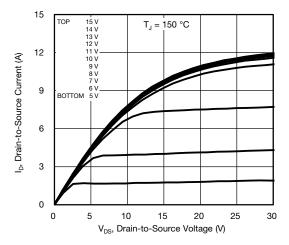


Fig. 2 - Typical Output Characteristics

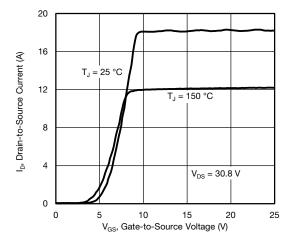


Fig. 3 - Typical Transfer Characteristics

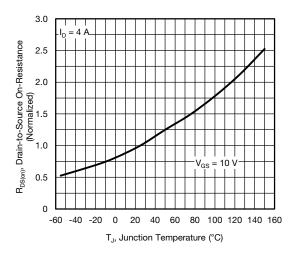


Fig. 4 - Normalized On-Resistance vs. Temperature

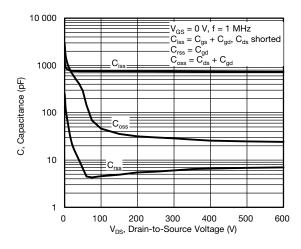


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

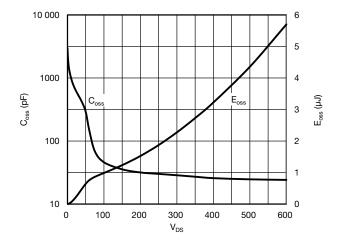


Fig. 6 - Coss and Eoss vs. VDS



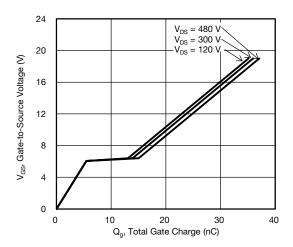


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

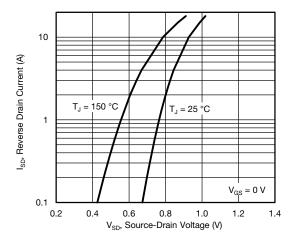


Fig. 8 - Typical Source-Drain Diode Forward Voltage

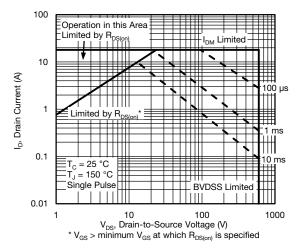


Fig. 9 - Maximum Safe Operating Area

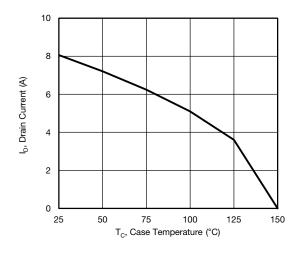


Fig. 10 - Maximum Drain Current vs. Case Temperature

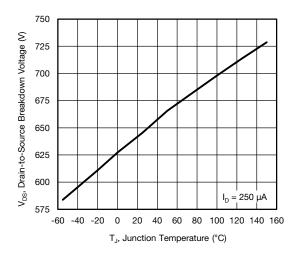


Fig. 11 - Temperature vs. Drain-to-Source Voltage



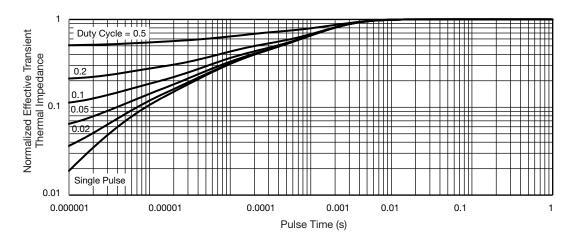


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

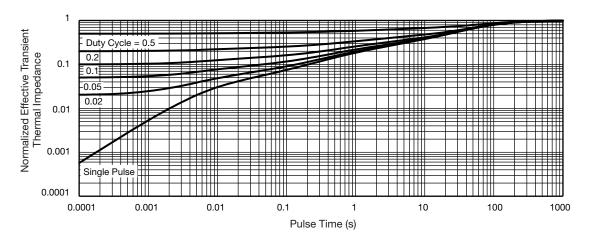


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

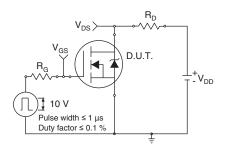


Fig. 14 - Switching Time Test Circuit

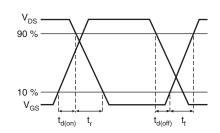


Fig. 15 - Switching Time Waveforms

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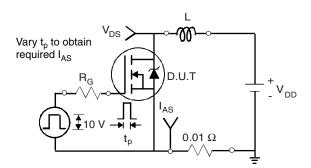


Fig. 16 - Unclamped Inductive Test Circuit

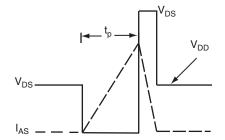


Fig. 17 - Unclamped Inductive Waveforms

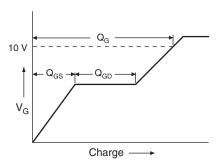


Fig. 18 - Basic Gate Charge Waveform

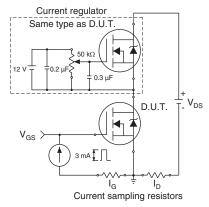
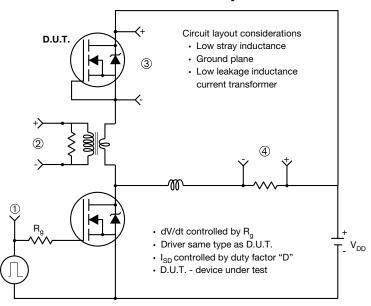


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



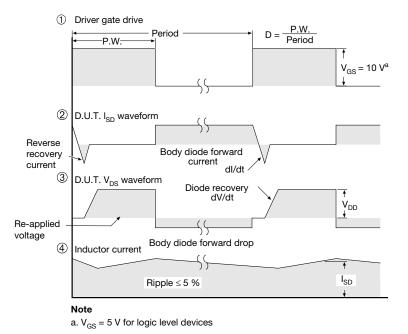
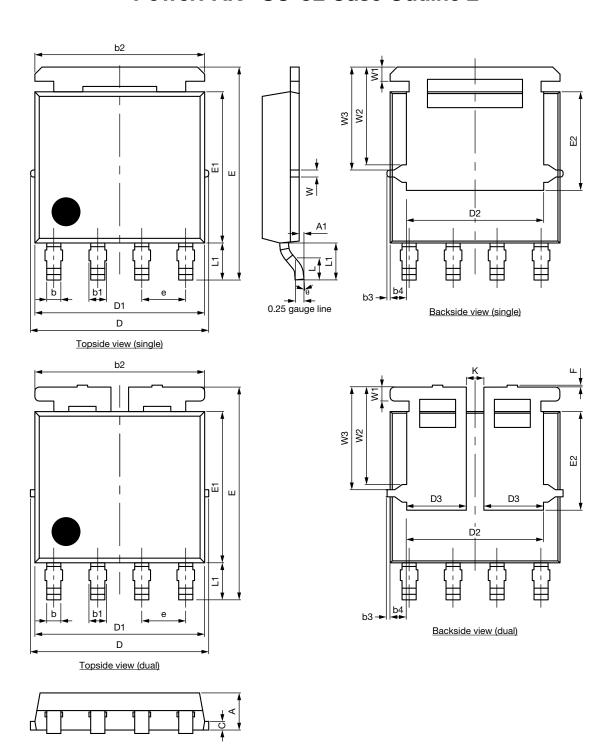


Fig. 20 - For N-Channel

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PowerPAK® SO-8L Case Outline 2



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DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	_		0.004	•	
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W	0.23		0.009				
W1	0.41			0.016			
W2	2.82		0.111				
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: C21-1498-Rev. C, 01-Nov-2021

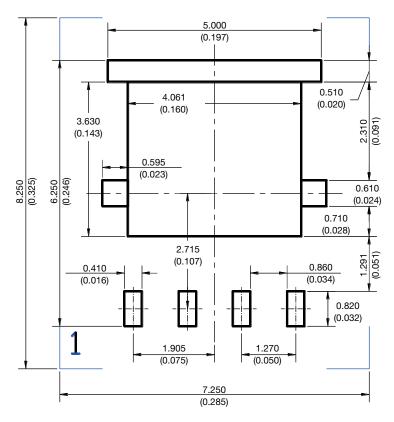
DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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